

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6836496

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the EXECUTION DATE OF THE 9TH AND 10TH INVENTORS previously recorded on Reel 056717 Frame 0787. Assignor(s) hereby confirms the CORRECT EXECUTION DATE FOR THE 9TH INVENTOR IS 05/17/2021 AND THE EXECUTION DATE FOR THE 10TH INVENTOR IS 05/18/2021.
CONVEYING PARTY DATA	
Name	Execution Date
TOSHIYUKI TAKAYANAGI	05/11/2021
NAOMOTO ISHIKAWA	05/11/2021
WATARU NISHIMURA	05/11/2021
NOBUYUKI KAMIHARA	05/11/2021
SOTA KAMO	05/11/2021
KIYOKA TAKAGI	05/11/2021
TAKASHI ISHIDA	05/11/2021
TOMOHARU DENGO	05/11/2021
MIKIO MURAOKA	05/17/2021
YUKIHIRO YOSHIDA	05/18/2021
RECEIVING PARTY DATA	
Name:	mitsubishi heavy industries, ltd.
Street Address:	2-3, MARUNOUCHI 3-CHOME, CHIYODA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	100-8332
Name:	AKITA UNIVERSITY
Street Address:	1-1, TEGATA GAKUEN-MACHI, AKITA-SHI
City:	AKITA
State/Country:	JAPAN
Postal Code:	010-8502
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17419793
CORRESPONDENCE DATA	
Fax Number:	(703)518-5499

PATENT

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-684-1111
Email: bjhgroupp@ipfirm.com
Correspondent Name: BENJAMIN J. HAUPTMAN
Address Line 1: 2318 MILL ROAD
Address Line 2: SUITE 1400
Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	4554-591
NAME OF SUBMITTER:	SHANNON LUKE
SIGNATURE:	/Shannon Luke/
DATE SIGNED:	07/28/2021

Total Attachments: 8

source=Assignment receipt#page1.tif
source=Assignment receipt#page2.tif
source=Assignment#page1.tif
source=Assignment#page2.tif
source=Assignment#page3.tif
source=Assignment#page4.tif
source=Assignment#page5.tif
source=Assignment#page6.tif



United States Patent and Trademark Office

[Home](#) | [Site Index](#) | [Search](#) | [Guides](#) | [Contacts](#) | [eBusiness](#) | [eBiz alerts](#) | [News](#) | [Help](#)*Electronic Patent Assignment System***Confirmation Receipt**

Your assignment has been received by the USPTO.
The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT																						
NATURE OF CONVEYANCE:	ASSIGNMENT																						
CONVEYING PARTY DATA																							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>TOSHIYUKI TAKAYANAGI</td><td>05/11/2021</td></tr><tr><td>NAOMOTO ISHIKAWA</td><td>05/11/2021</td></tr><tr><td>WATARU NISHIMURA</td><td>05/11/2021</td></tr><tr><td>NOBUYUKI KAMIHARA</td><td>05/11/2021</td></tr><tr><td>SOTA KAMO</td><td>05/11/2021</td></tr><tr><td>KIYOKA TAKAGI</td><td>05/11/2021</td></tr><tr><td>TAKASHI ISHIDA</td><td>05/11/2021</td></tr><tr><td>TOMOHARU DENGU</td><td>05/11/2021</td></tr><tr><td>MIKIO MURAOKA</td><td>05/11/2021</td></tr><tr><td>YUKIHIRO YOSHIDA</td><td>05/11/2021</td></tr></tbody></table>		Name	Execution Date	TOSHIYUKI TAKAYANAGI	05/11/2021	NAOMOTO ISHIKAWA	05/11/2021	WATARU NISHIMURA	05/11/2021	NOBUYUKI KAMIHARA	05/11/2021	SOTA KAMO	05/11/2021	KIYOKA TAKAGI	05/11/2021	TAKASHI ISHIDA	05/11/2021	TOMOHARU DENGU	05/11/2021	MIKIO MURAOKA	05/11/2021	YUKIHIRO YOSHIDA	05/11/2021
Name	Execution Date																						
TOSHIYUKI TAKAYANAGI	05/11/2021																						
NAOMOTO ISHIKAWA	05/11/2021																						
WATARU NISHIMURA	05/11/2021																						
NOBUYUKI KAMIHARA	05/11/2021																						
SOTA KAMO	05/11/2021																						
KIYOKA TAKAGI	05/11/2021																						
TAKASHI ISHIDA	05/11/2021																						
TOMOHARU DENGU	05/11/2021																						
MIKIO MURAOKA	05/11/2021																						
YUKIHIRO YOSHIDA	05/11/2021																						
RECEIVING PARTY DATA																							
<table border="1"><tr><td>Name:</td><td>MITSUBISHI HEAVY INDUSTRIES, LTD.</td></tr><tr><td>Street Address:</td><td>2-3, MARUNOUCHI 3-CHOME, CHIYODA-KU</td></tr><tr><td>City:</td><td>TOKYO</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>100-8332</td></tr></table>		Name:	MITSUBISHI HEAVY INDUSTRIES, LTD.	Street Address:	2-3, MARUNOUCHI 3-CHOME, CHIYODA-KU	City:	TOKYO	State/Country:	JAPAN	Postal Code:	100-8332												
Name:	MITSUBISHI HEAVY INDUSTRIES, LTD.																						
Street Address:	2-3, MARUNOUCHI 3-CHOME, CHIYODA-KU																						
City:	TOKYO																						
State/Country:	JAPAN																						
Postal Code:	100-8332																						
<table border="1"><tr><td>Name:</td><td>AKITA UNIVERSITY</td></tr></table>		Name:	AKITA UNIVERSITY																				
Name:	AKITA UNIVERSITY																						

PATENT**REEL: 057013 FRAME: 0728**

Street Address:	1-1, TEGATA GAKUEN-MACHI, AKITA-SHI
City:	AKITA
State/Country:	JAPAN
Postal Code:	010-8502

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17419793

CORRESPONDENCE DATA

Fax Number: (703)518-5499
 Phone: 703-684-1111
 Email: bjhgroupp@ipfirm.com
Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.
 Correspondent Name: BENJAMIN J. HAUPTMAN
 Address Line 1: 2318 MILL ROAD
 Address Line 2: SUITE 1400
 Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	4554-591
NAME OF SUBMITTER:	SHANNON LUKE
Signature:	/Shannon Luke/
Date:	06/30/2021

Total Attachments: 6
 source=Assignment#page1.tif
 source=Assignment#page2.tif
 source=Assignment#page3.tif
 source=Assignment#page4.tif
 source=Assignment#page5.tif
 source=Assignment#page6.tif

RECEIPT INFORMATION

EPAS ID: PAT6790392
 Receipt Date: 06/30/2021

[Return to home page](#)

[HOME](#) | [INDEX](#) | [SEARCH](#) | [eBUSINESS](#) | [CONTACT US](#) | [PRIVACY STATEMENT](#)

PATENT

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned Inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____: (Insert date of execution of application, if not concurrent)

(b) filed on _____,

Serial No. _____ / _____:

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) <u>Toshiyuki Takayanagi</u> (Signature)	<u>Toshiyuki TAKAYANAGI</u> (Type Name)	<u>May 11, 2021</u> (Date)
2) _____ (Signature)	<u>Naomoto ISHIKAWA</u> (Type Name)	_____ (Date)
3) <u>Wataru Nishimura</u> (Signature)	<u>Wataru NISHIMURA</u> (Type Name)	<u>May 11, 2021</u> (Date)
4) _____ (Signature)	<u>Nobuyuki KAMIHARA</u> (Type Name)	_____ (Date)
5) _____ (Signature)	<u>Sota KAMO</u> (Type Name)	_____ (Date)
6) _____ (Signature)	<u>Kiyoka TAKAGI</u> (Type Name)	_____ (Date)
7) _____ (Signature)	<u>Takashi ISHIDA</u> (Type Name)	_____ (Date)
8) _____ (Signature)	<u>Tomoharu DENGU</u> (Type Name)	_____ (Date)
9) _____ (Signature)	<u>Mikio MURAOKA</u> (Type Name)	_____ (Date)
10) _____ (Signature)	<u>Yukihiro YOSHIDA</u> (Type Name)	_____ (Date)

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest in the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292, and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on _____

Serial No. _____ / _____

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)")

The ASSIGNOR agree(s), when requested by said ASSIGNEE May 11, 2021 to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) _____ (Signature)	<u>Toshiyuki TAKAYANAGI</u> (Type Name)	_____ (Date)
2) <u>Naomoto Ishikawa</u> (Signature)	<u>Naomoto ISHIKAWA</u> (Type Name)	<u>May 11, 2021</u> (Date)
3) _____ (Signature)	<u>Wataru NISHIMURA</u> (Type Name)	_____ (Date)
4) _____ (Signature)	<u>Nobuyuki KAMIHARA</u> (Type Name)	_____ (Date)
5) _____ (Signature)	<u>Sota KAMO</u> (Type Name)	_____ (Date)
6) _____ (Signature)	<u>Kiyoka TAKAGI</u> (Type Name)	_____ (Date)
7) _____ (Signature)	<u>Takashi ISHIDA</u> (Type Name)	_____ (Date)
8) _____ (Signature)	<u>Tomoharu DENGO</u> (Type Name)	_____ (Date)
9) _____ (Signature)	<u>Mikio MURAOKA</u> (Type Name)	_____ (Date)
10) _____ (Signature)	<u>Yukihiro YOSHIDA</u> (Type Name)	_____ (Date)

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on _____

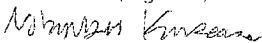
Serial No. _____ / _____

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) _____ (Signature)	Toshiyuki TAKAYANAGI (Type Name)	_____ (Date)
2) _____ (Signature)	Naomoto ISHIKAWA (Type Name)	_____ (Date)
3) _____ (Signature)	Wataru NISHIMURA (Type Name)	_____ (Date)
4)  (Signature)	Nobuyuki KAMIHARA (Type Name)	May 11, 2021 (Date)
5) _____ (Signature)	Sota KAMO (Type Name)	_____ (Date)
6) _____ (Signature)	Kiyoka TAKAGI (Type Name)	_____ (Date)
7) _____ (Signature)	Takashi ISHIDA (Type Name)	_____ (Date)
8) _____ (Signature)	Tomoharu DENGU (Type Name)	_____ (Date)
9) _____ (Signature)	Mikio MURAOKA (Type Name)	_____ (Date)
10) _____ (Signature)	Yukihiko YOSHIDA (Type Name)	_____ (Date)

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292, and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____: (Insert date of execution of application, if not concurrent)

(b) filed on _____

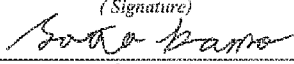
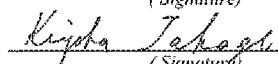
Serial No. _____ / _____

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) _____ (Signature)	Toshiyuki TAKAYANAGI (Type Name)	_____ (Date)
2) _____ (Signature)	Naomoto ISHIKAWA (Type Name)	_____ (Date)
3) _____ (Signature)	Wataru NISHIMURA (Type Name)	_____ (Date)
4) _____ (Signature)	Nobuyuki KAMIHARA (Type Name)	_____ (Date)
5)  (Signature)	Sota KAMO (Type Name)	May 11, 2021 (Date)
6)  (Signature)	Kiyoka TAKAGI (Type Name)	May 11, 2021 (Date)
7) _____ (Signature)	Takashi ISHIDA (Type Name)	_____ (Date)
8) _____ (Signature)	Tomoharu DENGU (Type Name)	_____ (Date)
9) _____ (Signature)	Mikio MURAOKA (Type Name)	_____ (Date)
10) _____ (Signature)	Yukihiro YOSHIDA (Type Name)	_____ (Date)

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292, and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on _____;

Serial No. _____ / _____;

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) _____ (Signature)	<u>Toshiyuki TAKAYANAGI</u> (Type Name)	_____ (Date)
2) _____ (Signature)	<u>Naomoto ISHIKAWA</u> (Type Name)	_____ (Date)
3) _____ (Signature)	<u>Wataru NISHIMURA</u> (Type Name)	_____ (Date)
4) _____ (Signature)	<u>Nobuyuki KAMIHARA</u> (Type Name)	_____ (Date)
5) _____ (Signature)	<u>Sota KAMO</u> (Type Name)	_____ (Date)
6) _____ (Signature)	<u>Kiyoka TAKAGI</u> (Type Name)	_____ (Date)
7) <u>Takashi Ishida</u> (Signature)	<u>Takashi ISHIDA</u> (Type Name)	<u>May 11, 2021</u> (Date)
8) <u>Tomoharu Dengo</u> (Signature)	<u>Tomoharu DENGO</u> (Type Name)	<u>May 11, 2021</u> (Date)
9) _____ (Signature)	<u>Mikio MURAOKA</u> (Type Name)	_____ (Date)
10) _____ (Signature)	<u>Yukihiro YOSHIDA</u> (Type Name)	_____ (Date)

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

MITSUBISHI HEAVY INDUSTRIES, LTD.

2-3, Marunouchi 3-chome, Chiyoda-ku, Tokyo 100-8332 Japan

Akita University

1-1, Tegata Gakuen-Machi, Akita-shi, Akita 010-8502 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

COMPOSITE MATERIAL FORMING METHOD

relating to International Patent Application PCT/JP2020/001292 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____; (Insert date of execution of application, if not concurrent)

(b) filed on _____

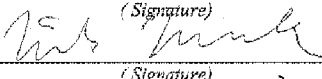
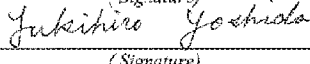
Serial No. _____ / _____

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) _____ (Signature)	Toshiyuki TAKAYANAGI (Type Name)	_____ (Date)
2) _____ (Signature)	Naomoto ISHIKAWA (Type Name)	_____ (Date)
3) _____ (Signature)	Wataru NISHIMURA (Type Name)	_____ (Date)
4) _____ (Signature)	Nobuyuki KAMIHARA (Type Name)	_____ (Date)
5) _____ (Signature)	Sota KAMO (Type Name)	_____ (Date)
6) _____ (Signature)	Kiyoka TAKAGI (Type Name)	_____ (Date)
7) _____ (Signature)	Takashi ISHIDA (Type Name)	_____ (Date)
8) _____ (Signature)	Tomoharu DENGU (Type Name)	_____ (Date)
9)  (Signature)	Mikio MURAOKA (Type Name)	May 17, 2021 (Date)
10)  (Signature)	Yukihiko YOSHIDA (Type Name)	May 18, 2021 (Date)